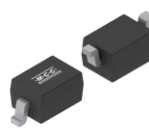


**30V, 0.2A Schottky Barrier Diode**

**Product Summary**

Parameter	Rating
$V_{RRM}$	30 V
$V_F \text{ Max @ } 100\text{mA}$	1000 mV
$I_{F(AV)}$	200 mA
$I_R \text{ Max @ } V_R = 25 \text{ V}$	2 $\mu\text{A}$



**Features**

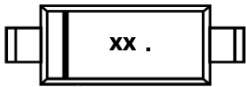

- High Reliability
- Low Forward Voltage and Low Reverse Current

**SOD-323**

**Mechanical Data**

- Package: SOD-323
- Moisture Sensitivity: Level 1, per J-STD-020
- Halogen Free. "Green" Device (Note<sup>1</sup>)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish & RoHS Compliant
- Weight: 0.004 g (approximate)

**Body Marking and Pin Layout**

Body Marking	Internal structure
 <p><b>XX</b>: Device Marking Code<sup>1</sup>  <b>Bar</b>: Cathode Pin indicator  <b>Dot</b>(optional): Manufacturing Site Marking</p> <p><sup>1</sup>   Refer to the ordering information for the specific device code.</p>	

**Ordering Information**

Ordering Product Name	Device Marking Code	Reel Size	Packing Type	Qty/Reel
BAT54WS-TP	L9	7"	Tape & Reel	3,000
BAT54WS-13P	L9	13"	Tape & Reel	10,000

For packaging details, visit our website at <https://www.mccsemi.com/Package/List>

## 30V, 0.2A Schottky Barrier Diode

 Maximum Ratings ( $T_A=25^\circ\text{C}$  unless otherwise specified)

Parameter	Symbol	Rating	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	30	V
RMS Reverse Voltage	$V_{R(RMS)}$	21	V
Reverse Voltage	$V_R$	30	V
Average Forward Current	$I_{F(AV)}$	200	mA
Non-Repetitive Peak Surge Current	$I_{FSM}$	600	mA
$t_p = 8.3\text{ms}$ Sine Wave, $T_J = 25^\circ\text{C}$			
Power Dissipation <sup>(Note 2)</sup>	$P_D$	200	mW
Operating Junction Temperature Range	$T_J$	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55 to +150	$^\circ\text{C}$

- Notes:
- Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  - Device mounted on an FR4 Printed-Circuit Board (PCB) with the recommended pad layout.

 Thermal characteristics ( $T_A=25^\circ\text{C}$  unless otherwise specified)

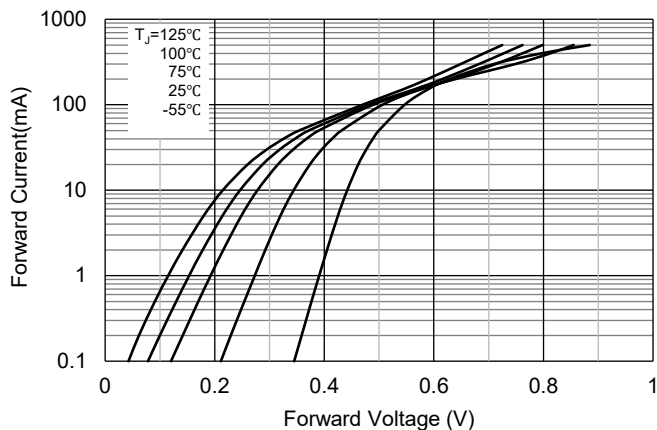
Parameter	Symbol	Rating	Unit
Thermal Resistance from Junction to Ambient <sup>(Note 2)</sup>	$R_{\theta JA}$	500	$^\circ\text{C}/\text{W}$

 Electrical Characteristics ( $T_A=25^\circ\text{C}$  unless otherwise specified)

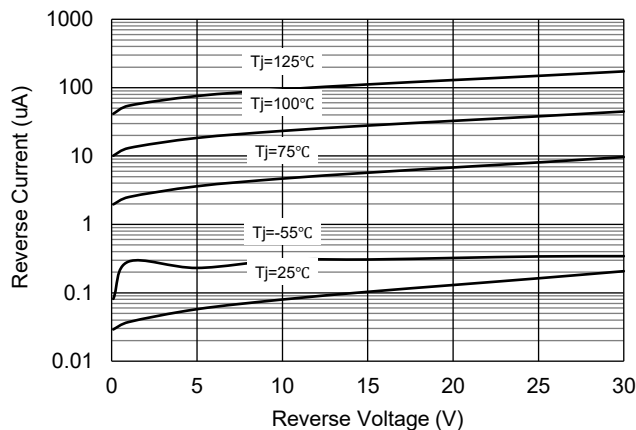
Parameter	Test Conditions	Symbol	Min	Typ	Max	Unit
Reverse Breakdown Voltage	$I_R = 100 \mu\text{A}$ (pulse test)	$V_{BR}$	30			V
Forward Voltage	$I_F = 0.1 \text{ mA}$	$V_F$			0.24	V
	$I_F = 1 \text{ mA}$				0.32	
	$I_F = 10 \text{ mA}$				0.4	
	$I_F = 30 \text{ mA}$				0.5	
	$I_F = 100 \text{ mA}$				1	
Reverse Current	$V_R = 25 \text{ V}$	$I_R$			2	$\mu\text{A}$
Junction Capacitance	$V_R = 1 \text{ V}$ , $f = 1.0\text{MHz}$	$C_J$			10	pF
Reverse Recovery Time	$I_F = 10\text{mA}$ , $I_R = 10\text{mA}$ , $I_{rr} = 0.1 \times I_R$ , $R_L = 100\Omega$	$t_{rr}$			5	ns

**Curve Characteristics**

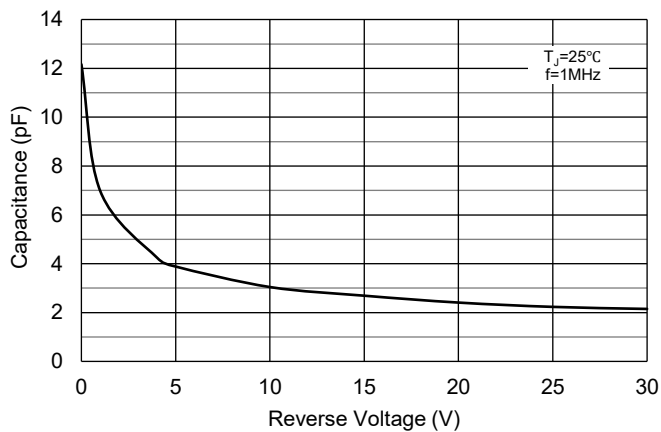
**Fig.1 - Typical Instantaneous Forward Characteristics (per diode)**



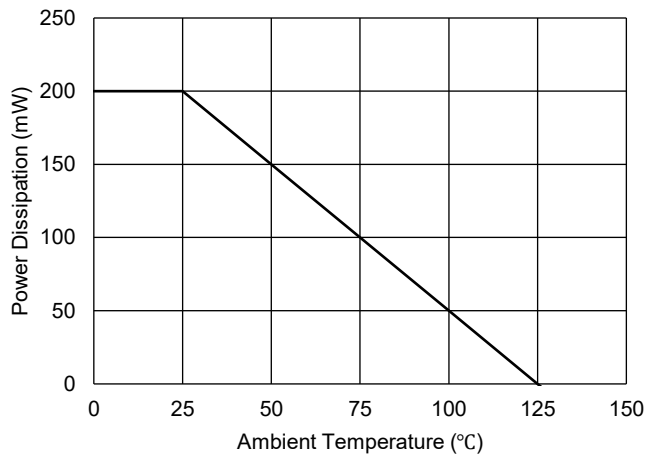
**Fig.2 - Typical Reverse Leakage Characteristics (per diode)**



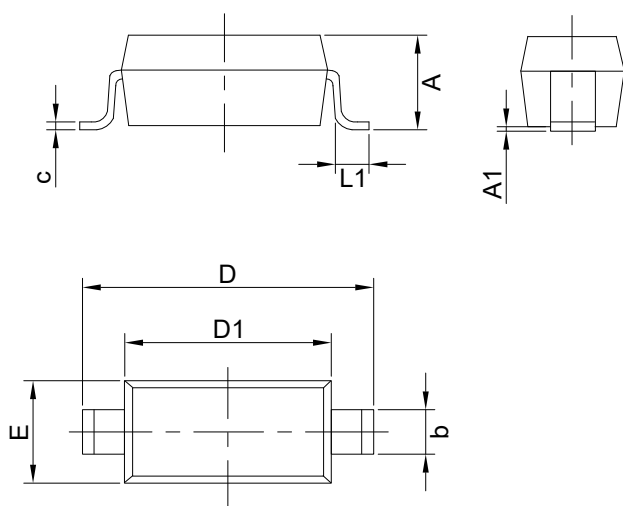
**Fig.3 - Typical Capacitance Characteristics (per diode)**



**Fig.4 - Power Derating Curve**



## Package Outline

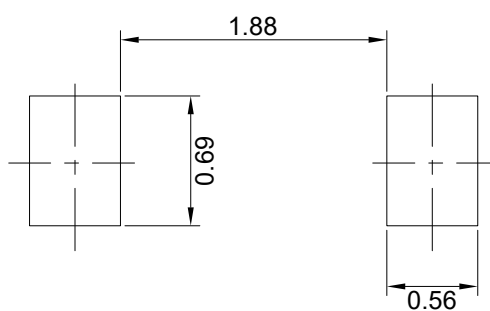


DIM	INCH		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.031	0.045	0.80	1.15*	Note 1
A1	0.000	0.006	0.00	0.15	
b	0.010	0.016	0.25	0.40	
c	0.003	0.010	0.08	0.25	
D	0.090	0.107	2.30	2.70	
D1	0.063	0.071	1.60	1.80	
E	0.045	0.055	1.15	1.40	
L1	0.004	0.018	0.10	0.45	

**Notes:**

1. Dimension A for products from manufacturing site VN is controlled at max 1.10 mm.

## Suggested Pad Layout (Unit:mm)



**Notes:**

1. The suggested land pattern dimensions have been provided for reference only.
2. For further information, please refer to document IPC-7351A.

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